



压差、补偿压力传感器（0至**10**千帕）

MPXC201xDT1

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MPXC201xDT1是一个高性价比、大量程微型压力传感器封装产品，适用于医疗应用。

- 它是子模块组件或一次性使用元件的理想解决方案
- 采用了我们带压阻技术的传感器晶片，同时添加了片上薄膜温度补偿及校准功能
- 降低了系统设计成本，提高了灵活性

MPXC201XDT1_BD Block Diagram

PACKAGING ORDERING INFORMATION

Device Type	Packing Options	Case
MPXC2011DT1	Chip Pak, 1/3 Gel	423A
MPXC2012DT1	Chip Pak, No Gel	423A

View additional information for [压差、补偿压力传感器（0至10千帕）](#).

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